

ATSC 2005

1st Asian Thermal Spray Conference
28th November – 29th November 2005
Nagoya Congress Center
Nagoya, Japan



1st Call for Papers

ORGANIZED BY:

Asian Thermal Spray Committee - J
Japan Thermal Spraying Society
High Temperature Society of Japan

SPONSORED BY:

Japan Thermal Sprayers Association, Toyohashi University of Technology

SUPPORTED BY:

The Japan Institute of Metals, Japan Association of Corrosion Control
The Iron and Steel Institute of Japan, Japan Welding Society
The Japan Society of Mechanical Engineers
The Surface Finishing Society of Japan, The Ceramic Society of Japan

Conference Chairman

Prof. M. Fukumoto (*Toyohashi University of Technology*)

International Advisory Board

A. Ohmori(J), Y. Tsunekawa(J), A. Nakahira(J), M. Seki(J), X. Huang(C), S-C. Kwon(K)

Website of ATSC2005

<http://www.j-tss.jp/atsc2005/>

Exhibition

Information about exhibition will be available on the home page.

Scope of Conference

The purpose of this annual conference is to bring together state-of-the-art developments on all aspects related to Thermal Spray in Asia. This conference will be held in countries such as China, Korea, Singapore and Japan alternately in the future. The conference will certainly provide an attractive forum for presenting the latest advances in thermal spray by researchers and engineers from industry, research laboratories, and academia. It is also expected to provide younger engineers and researchers in Asia with opportunities to learn about this fast-evolving technology, meet experts, and attain international experience. Both INVITED and CONTRIBUTED papers will be included.

Important Dates

Abstracts due	15 July 2005
Acceptance of abstract	1 August 2005
Paper submission	1 October 2005

Submission of Abstracts

Any delegate wishing to present a paper must send an abstract (150-200 words) to the program committee: Prof. K. Ogawa, e-mail: atsc2005@rift.mech.tohoku.ac.jp (preferred, as an attached file or mail). The deadline for receiving abstracts is **15th July 2005**. Abstracts have to be submitted in English and typed in single-line spacing using Time 12 pt type and should be headed with the title (in CAPITALS and center justified and bold), name(s) and affiliation(s) of all authors, and correspondence for mailing and e-mailing address. Authors will be notified of the acceptance of their paper(s) by **1 August 2005**.

Proceedings

Papers will be accepted for presentation and poster. 2-page long, camera-ready manuscripts should be submitted preferably in PDF format for inclusion in the proceedings by **1 October 2005**. After review, all the accepted papers will be published in the conference proceedings to be made available at the conference. Authors wishing to publish their full-length papers (6-page long) are requested to bring their manuscript ready for submission to **Materials Transactions** at the conference. Manuscripts for proceedings should also be sent to Prof. K. Ogawa, e-mail: atsc2005@rift.mech.tohoku.ac.jp

Conference Secretariat

Prof. S. Oki, E-mail: sachio@mech.kindai.ac.jp

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For more information, please visit web site: <http://www.i-tss.jp/atsc2005/>